High Power Laser Diode Chip



Part Number: CHP-128

High Power Chip Single-Mode Fabry-Perot CW Wavelength at 1625nm



Features

- High Output Power
- High Dynamic Range
- High Efficiency
- Standard Bare Die
- Cost Effective

Application

- Laser Rangefinders
- Military System
- OTDR



SemiNex delivers the highest available power at infrared wavelengths between 12xx and 19xx nm. When necessary, we will further optimize the design of our InP & GaSb laser chips to meet our customers' specific optical and electrical performance needs. Diodes, bars and packages are tested to meet customer and market performance demands. Typical results and packaging options are shown. Contact SemiNex for additional details or to discuss your specific requirements.

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CHP-128

Optical	Symbol	Тур.	Units
Center Wavelength	λ _c	1625	nm (±20)
Output Power (CW)*	Pout	0.45	watts (±10%)
Chip Cavity Length	CL	2500	μm
Emitter Width	W	4	μm
Spectral Width FWHM	Δλ	15	nm
Slope Efficiency	η	0.3	W/A
Fast Axis Div.	Θ⊥	30	deg FWHM
Slow Axis Div.	Θ _{II}	13	deg FWHM
Electrical	Symbol		Units
Electrical Power Conversion Eff.	Symbol η	14	Units %
		14 0.05	
Power Conversion Eff.	η		%
Power Conversion Eff. Threshold Current	η Ітн	0.05	% A
Power Conversion Eff. Threshold Current Operating Current	η Ітн І _{ор}	0.05 1.6	% A A
Power Conversion Eff. Threshold Current Operating Current Operating Voltage	η Ітн І _{ор}	0.05 1.6 3.6	% A A V

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*Specified values are rated at a constant heat sink temperature of 20°C. **High temperature operation will reduce performance and MTTF.

Unless otherwise indicated all values are nominal.



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SemiNex Laser Diodes CHP-128

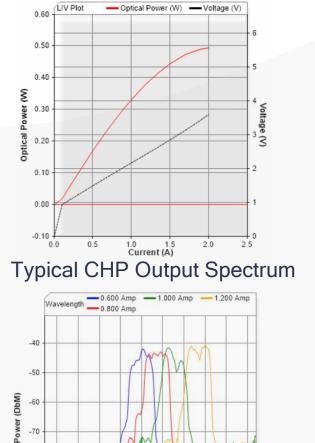
Graphs & Data

-80

-90

-100

Typical CHP L-I-V Characteristics



1,580 1,590 1,600 1,610 1,620 1,630 1,640 1,650 1,660 1,670 Wavelength (nm)

*Graphs and Data were collected from mounted parts

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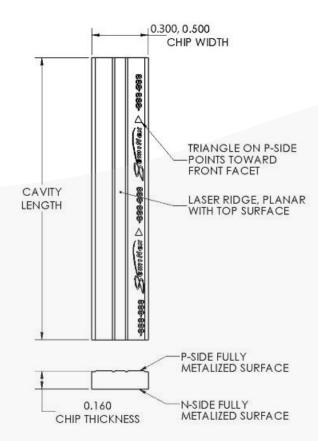






Mechanical Drawing





CHIP ATTRIBUTES

APERTURE WIDTH (µm)	Single Mode (4, 5) ± 1 Multi Mode (50, 95, 180, 350) ± 3
CHIP WIDTH (µm)	300, 500 ± 10
THICKNESS (µm)	160 ± 10
CAVITY LENGTH (µm)	Varies ± 10

P METALIZATION

MATERIAL	THICKNESS (nm)	TOLERANCE (nm
Ti	50	± 10
Pt	125	± 25
Au	250	± 50

N METALIZATION

MATERIAL	THICKNESS (nm)	TOLERANCE (nm)
Ti	30	± 10
Pt	125	± 25
An	400	+ 40

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